PATENT ASSIGNMENT

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SUBMISSION TYPE:		NEW ASSIGNMENT					
NATURE OF CONVEYANCE:		ASSIGNMENT					
CONVEYING PARTY DATA							
		N	ame	Execution Date			
Hajime CHINO				05/09/2012			
Masaru WATAHIKI				05/09/2012			
Toru IWAYA				05/09/2012			
RECEIVING PARTY DATA							
Name:	HITACHI HIGH-TECHNOLOGIES CORPORATION						
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City:	Токуо						
State/Country:	JAPAN	JAPAN					
Postal Code:	105-8717						
PROPERTY NUMBERS Total: 1							
Property Type			Number				
Application Number: 13		13511	Number 1810				
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ATTORNEY DOCKET NUMBER:			2451.190BS				
NAME OF SUBMITTER:		Carl I. Brundidge					
Total Attachments: 1 source=2451_Assignment#page1.tif							
PATENT							

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI HIGH-TECHNOLOGIES CORPORATION, a corporation organized under the laws of Japan, located at 24-14, Nishi Shimbashi 1-chome, Minato-ku, Tokyo, 105-8717 Japan, receipt of which is hereby acknowledged, I do hereby sell and assign to said HITACHI HIGH-TECHNOLOGIES CORPORATION, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

CHARGED-PARTICLE MICROSCOPE AND METHOD FOR CONTROLLING SAME

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI HIGH-TECHNOLOGIES CORPORATION, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI HIGH-TECHNOLOGIES CORPORATION.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

	(発明者フルネームサイン)	(署名日)
1)	Hajime Chino Hajime CHINO	5/9/2012
2)	Masaru Watahiki Masaru WATAHIKI	5/9/2012
3)	<u> Γου Iwaya</u> Toru IWAYA	5/9/2012
4)		
5)		

PATENT REEL: 028265 FRAME: 0523

Note Signed

RECORDED: 05/24/2012

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